

Amendments to the Specification:

Please replace the paragraph beginning at page 10, line 28, with the following re-written paragraph:

This process is illustrated in Fig. 1, wherein Fig. 1a shows a solar cell foil comprising a temporary substrate 1 with on top of it a ~~TCO 2a;2b~~TCO 2, a PV layer 3, a back electrode 4, and a permanent substrate 5. The interconnect 6 connects the TCO layer to the back electrode 4. An etch resist cap 7 is provided on the temporary substrate at the location of the interconnect. In Fig. 1b the same system is shown after removing the temporary substrate except where it is provided with the etch resist cap. No etch resistant is present at the location of the front groove fg, thus no remainder of the temporary substrate (usually a conductor such as aluminum) is present at the location of the front groove fg to cause short-circuit between separated TCO parts 2a and 2b.